TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSIV)

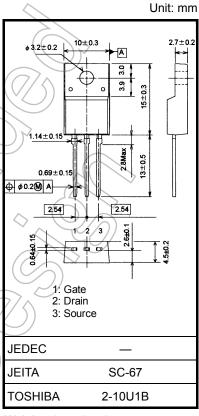
2SK3566

Switching Regulator Applications

- Low drain-source ON-resistance: $R_{DS (ON)} = 5.6 \Omega (typ.)$
- High forward transfer admittance: |Y_{fs}| = 2.0 S (typ.)
- Low leakage current: $I_{DSS} = 100 \mu A \text{ (max) (V}_{DS} = 720 \text{ V)}$
- Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C) Characteristics Symbol

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	900	V
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	900	A
Gate-source voltage		V _{GSS}	<u>+</u> 30	> v
Drain current	DC (Note 1)	I _D	2.5	
	Pulse (t = 1 ms) (Note 1)	I _{DP}	7.5	A
Drain power dissipation (Tc = 25°C)		PD	40	<\\w
Single pulse avalanche energy (Note 2)		EAS	216	mJ
Avalanche current		TAR	2.5	(A
Repetitive avalanche energy (Note 3)		EAR	4	Jwh
Channel temperature		7) Tch	150	°C
Storage temperature range		Teta	-55 to 150	→°C



Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	3.125	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

10

- Note 1: Please use devices on conditions that the channel temperature is below 150°C.
- Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$, L = 63.4 mH, $I_{AR} = 2.5 \text{ A}$, $R_G = 25 \Omega$
- Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device. Please handle with caution.

Start of commercial production 2002-06

Electrical Characteristics (Ta = 25°C)

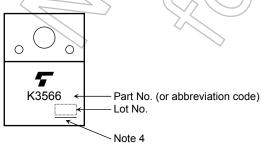
Char	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rrent	I _{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ
Gate-source brea	akdown voltage	V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	V
Drain cut-off curr	ent	I _{DSS}	V _{DS} = 720 V, V _{GS} = 0 V	/_	_	100	μА
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	900	_	_	V
Gate threshold v	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0) / _	4.0	V
Drain-source ON	-resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 1.5 A	,) <u> </u>	5.6	6.4	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 20 V, I _D = 1.5 A	1.0	2.0	_	S
Input capacitance	e	C _{iss}		_	470	_	
Reverse transfer	capacitance	C _{rss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	7	10	_	pF
Output capacitance		C _{oss}		_	50	_	
Switching time	Rise time	t _r	10 V I _D = 1.5 A V _{OUT} V _{GS}		20		
	Turn-on time	t _{on}	50Ω \$ RL =		60) —	20
	Fall time	t _f	V _{DD} ≈ 200 V	7	> 30		ns
	Turn-off time	t _{off}	Duty ≤ 1%, t _w = 10 μs		100		
Total gate charge	е	Qg) —	12	_	
Gate-source cha	rge	Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2.5 \text{ A}$	_	7	_	nC
Gate-drain charg	e	Qgd			5	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}		_	_	2.5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	<u> </u>		_	7.5	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 2.5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	$I_{DR} = 2.5 \text{ A}, V_{GS} = 0 \text{ V},$	_	720	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 100 A/μs		3.6	_	μС

2

Marking

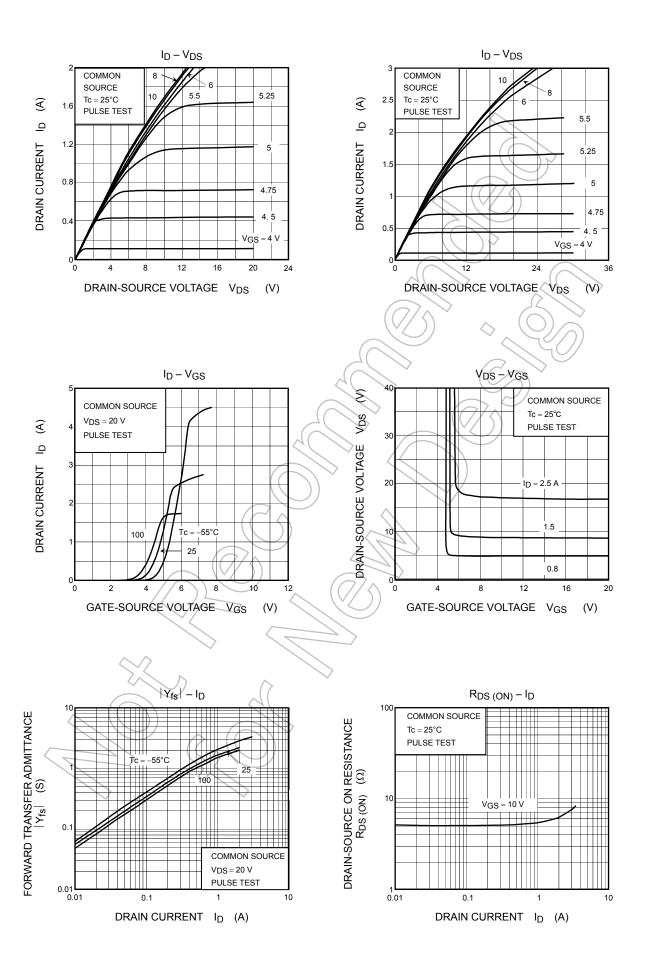


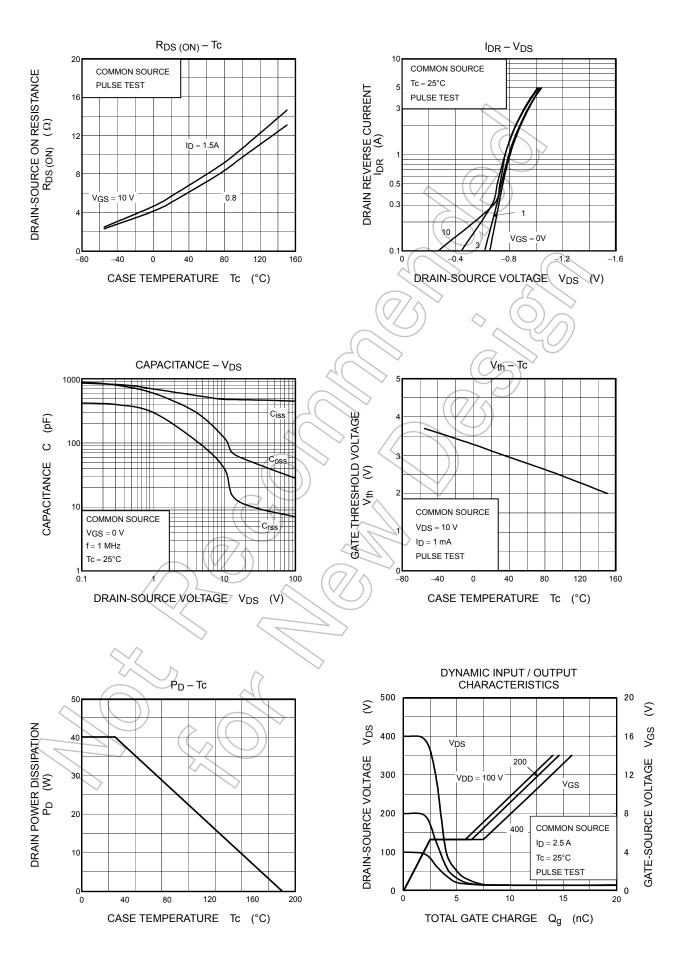
Note 4: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

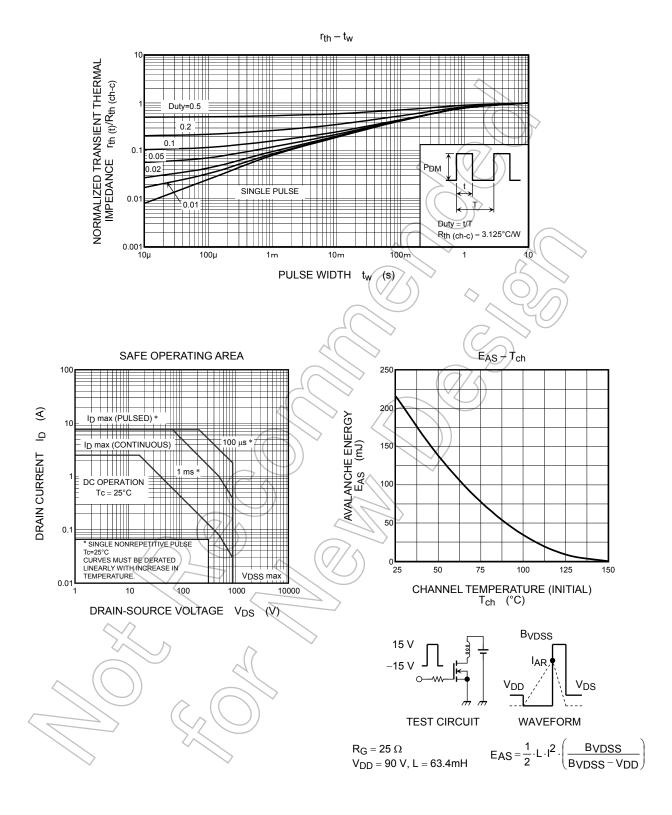
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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4



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